UHV Flow Cryostat - Helitran®

The ARS manufactured LT3B Helitran is a True UHV cold head (10-11 Torr) where all of the rubber o-ring seals have been replaced with welded joints and metal seals. Like all of our LT3 helium flow cryostats, the LT3B is an advanced liquid helium flow cryostat utilizing many unique features, such as the matrix heat exchanged and the coaxial shield flow transfer line to achieve unparalleled efficiency and ultra low vibration levels. The combination of True UHV and angstrom level vibrations makes the LT3B ideal for low temperature STM application. For UHV surface science where very long cold fingers are required we have the LT3M with customizable length up to 1200 mm and rigid support tube to allow for cleaving and manipulation.

Applications

- UHV
- STM
- Surface Science

Features

- True UHV (10-11 Torr)
- Bakeable to 200C
- Open Sample Space
- Optional Cold Tip Extensions
- Liquid Helium Flow (or Liquid Nitrogen(
- Matrix Heat Exchanged for High Cooling Efficiency
- Coaxial Shield Flow Transfer Line
- 4.2K Liquid Helium Operation (1.7K with Pumping)
- 0.7 LL/hr Liquid Helium Consumption at 4.2K (tip flow)
- Angstrom Level Vibrations
- Precision Flow Control
- Exhause Heater
- Operation in ANY Orientation
- Fully Customizable

Typical Configuration

- Cold head (LT3B)
- Coaxial Shield Flow Transfer Line
- True UHV welded stainless steel instrumentation skirt with 2.75 in rotatable CF flange
- Dewar Adapter
- Flow Meter Panel for Helium Flow Control and Optimization
- Nickel Plated OFHC Copper Radiation Shield terminating 0.125 inch short of the cold tip
- Instrumentation for temperature measurement and control:
 - 10 pin UHV feed through 36 ohm thermofoil heater (wire wrapped) Silicon diode sensor curve matched to $(\pm 0.5K)$ for control Calibrated silicon diode sensor $(\pm 12 \text{ mk})$ with 4 in. free length for accurate sample measurement.
- Wiring for electrical experiments: 10 pin hermetic feed through
 - 4 copper wires
- Sample holder for optical and electrical experiments
- Temperature Controller

Options and Upgrades

- High Flow Transfer Line
- 4.5 and 6 inch rotatable CF flanges available
- 450K High Temperature Interface
- 800K High Temperature Interface
- Custom temperature sensor configuration (please contact our sales staff
- Custom wiring configurations (please contact our sales staff)
- Sample holder upgrades (custom sample holders available)

DS-LT3B-R1



The above picture shows LT3B Helitran $\ensuremath{\mathbb{R}}$ with a radiation shield.





UHV Flow Cryostat - Helitran®

Cooling Technology-

LT3	Open Cycle Cryocooler, Helitran
Refrigeration Type	Liquid Helium Flow
Liquid Cryogen Usage	Helium, Nitrogen Compatible

Temperature*-

LT3B	< 4.2K - 350K (<2K with pumping)	
With 800K Interface	(Base Temp + 2K) - 700K	
With 450K Interface	Base Temp - 450K	
Stability	0.002 K	
*Based on bare cold head with a closed radiation shield, and no additional sources of experimental or parasitic heat load		

Sample Space -

Diameter	Large Open Radiation Shield
Height	Large Open Radiation Shield
Sample Holder Attachment	1/4-28 screw
Sample Holder	www.arscryo.com/Products/ SampleHolders.html

Temperature Instrumentation and Control - (Standard) -

	Heater	36 ohm wire wrapped Thermofoil Heater anchored to the coldtip
	Control Sensor	Curve Matched Silicon Diode installed on the coldtip
	Sample Sensor	Calibrated Silicon Diode with free length wires
	Contact ARS for other options	

Instrumentation Access-

Instrumentation Skirt	Welded Stainless Steel
Pump out Port	1 - NW 25
Instrumentation Ports	2 (1.33 Mini Conflat Flanges)
Instrumentation Wiring	Contact sales staff for options

Radiation Shield -

Material	Nickel Plated OFHC Copper
Attachment	Threaded
Optical Access	Open End Radiation Shield terminated 0.125" short of cold tip (Customer Specified)

Cryostat Footprint -

Overall Length	326 mm (12.84 in)
Motor Housing Diameter	N/A
Rotational Clearance	121 mm (4.8 in) with "G" Configuration

Cryostat Model		LT3		
Cryogen		Liquid Helium		Liquid Nitrogen
Base Temperature		4.2K	<2K with Pumping	77K
Nominal Helium Cons	sumption at 4.2K	0.7 LL/hr	-	
Cooling Capacity		0.7 LL/hr	2 LL/hr	
	4.2K	0.5W	1.5W	
	20K	3.0W	8.0W	
	50K	7W	20W	
Maximum Temperature Cooldown Time Weight		450K with cold ga	as through transfer line	
		2	20 min	
		0.9 kg (2 lbs)		



LT3B Outline Drawing





LT3B Vibration Image



Courtesy of: Hyojune Lee University of California Los Angeles Electrical Engineering Department Helitran® LT3B Connected Directly to STM Scanner. Scan Size Approx: 62Å x 62Å Noise in the image is < 3 Å

STM Image



Courtesy of: Prof. Michael F. Crommie, University of California at Berkeley Physics Department Helitran® LT3B 120 x 120 Angstrom image of azobenzene molecules on Au(111) taken at T = 15K

UHV - STM- SURFACE SCIENCE

Helitran[®] LT-3B FOR UHV and STM:

This is the UHV model. It is manufactured from UHV grade materials and instrumentation. The LT-3B has the following features: Sample in UHV. (10E-11 Torr)

Interface is Conflat Flange, 2.75 Inch Conflat. (DN-35CF)

Temperature Range; 4.2-500K Standard. (1.7K with Pumping). 4.2K to 900K with HiTempTm Interface.

Matrix Heat Exchanger integrated with sample mount.

Co-axial Transfer Line for reduced flow of single phase Helium.

Applications:

Scanning Tunneling Microscope. STM: the Helitran[®] is uniquely designed for the STM application. With the Coaxial flow transfer line and the Matrix Heat Exchanger combination the vibrations at the STM are less than 1Å. Scientists have used the Helitran to cool STM samples to less than 8K with drift less than 0.001 Å per minute.

Helitran[®] LT-3M for Surface Science and UHV Manipulator:

This is the UHV cryostat is designed with an extended length for surface science experiments. It is typically mounted on a UHV manipulator. The LT-3M has the following features:

Sample in UHV. (10E-11 Torr)

Interface is Conflat Flange, 4.5 Inch Conflat. (DN-63CF)

Temperature Range; 4.2-500K Standard. (1.7K with Pumping).

Matrix Heat Exchanger integrated with sample mount. This is important because of the typical larger size of the sample holders (Due to tilt and rotation requirements)

Co-axial Transfer Line for reduced flow of single phase Helium. Applications:

Surface Science/UHV Manipulators: the Helitran[®] is uniquely designed for the UHV mainpulator. With the Matrix Heat Exchanger the helium consumption is dramatically reduced.

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Advanced Features of LT3B Helitran[®]

The Helitran® has been designed for high performance with advanced features not normally found in traditional open cycle cryostats. A detailed description of the Matrix Heat Exchanger, the Adjustable Impedance Valve and the Coaxial Transfer Line is presented in this paper

Helium Consumption:

Heat Exchangers (at the sample mount) for cost reasons. The liquid helium is contained in a reservoir similar to a copper cup over the sample mount. As the helium boils and evaporates only the latent heat of vaporization is used to cool the sample mount, there is no provision to capture the Impedance Valve by attaching a vacuum pump, this reduces the presthe enthalpy of the gas as it escapes from the cryostat at 4.2K regardless sure of the helium as it flows through the Matrix Heat Exchanger . The of the sample temperature. The cooling power of the gas is wasted. Enthalpy of Helium gas from 4.2 to 300K is substantial at 1542 Joules/gm.

The Helitran[®] incorporates an extended surface tip heat exchanger (Matrix Heat Exchanger) which provides efficient heat transfer between the helium and the sample mount. The Liquid helium flows through this heat exchanger and as the latent heat of vaporization cools the sample thermal conductivity is equal to that of copper from 4-300K but it becomes mount, the liquid evaporates, the gas continues to flow through the exchanger providing additional cooling (capturing the enthalpy of the gas) to Heat exchanger protects the cryostat. the sample mount. If the flow is optimized the helium gas will exit the Matrix Heat Exchanger at a temperature equal to the sample temperature.

Helium usage is dramatically reduced as reported by J. B. Jacobs in Advances in Cryogenic Engineering, Volume 8, 1963, Page 529 as follows:

Amount of Cryogenic fluid required to cool metals (Liters/Kg.) to 4.2K.

Cryogen	⁴He	⁴He
Initial Temperature of 1 Kg of Copper.	300K	77K
Final Temperature of 1 Kg of Copper,	4.2K	4.2K
Using the latent heat of vaporization only.	31.1 Liters of Helium	2.16 Liters of Helium
(Inefficient Heat Transfer)		
Using the Enthalpy of Gas.	0.79 Liters of Helium	0.15 Liters of Helium
(Efficient Heat Transfer)		

From this it is clear that for any sample size the consumption of He during initial cooldown is 40 times higher without an extended surface cryostat tip heat exchanger from 300K (room temperature) to 4.2K and 14 times higher when cooling from 77K to 4.2K.

Temperature Range:

Conventional Helium Flow Cryostats do not incorporate extended surface Sub 4.2K Operation: The temperature of helium drops to 1.8K when the pressure is reduced across an Adjustable Impedance Valve. Pumping on a reservoir, as in a traditional system is not practical as all the helium will evaporate rather quickly. In the Helitran® the suction is applied against matrix heat exchanger and the conductively coupled sample mount are cooled to below 1.8K.

> 800K Operation: The high temperature can be achieved by incorporating a thermal switch, composed of a sapphire and OFHC copper arrangement as shown below. The unique property of sapphire is utilized, where its a thermal insulator above 300K. The high cooling power of the Matrix



Temperature Stability:

Conventional helium flow cryostats utilize a capillary tube in a vacuum jacket with superinsulation to reduce the radiant heat load. However as the helium absorbs radiant heat the liquid is vaporized and forms bubbles of gas which have a larger volume than the liquid thus forming a temporary block to the flow of the liquid called "vapor binding". At the delivery end of the transfer line this results in the liquid/gas mixture being delivered in spurts with accompanying pressure and temperature cycling.

The coaxial flow transfer line incorporates a shield flow (See figure) surrounding the tip flow for the entire length of the transfer line. The entrance to the coaxial shield flow tube is provided with a nozzle which results in a pressure and corresponding temperature drop in the shield flow which subcools the tip flow in the center tube. This subcooling prevents boiling and gas bubble formation in the helium, even at very low flow rates. The Helium is delivered at the sample end with the desired temperature stability and low vibrations.



Cryostat Design Features





Helium Flow Transfer Line Features





- nozzle, the resulting pressure and temperature drop sub cools the tip flow. 3. Shield flow is surrounded by copper foil radiation shield
- Smeld now is surrounded by copper foil radiation shield plus superinsulation in vacuum jacket.
- Sub cooled tip flow is delivered as 100% liquid at very precise and low flow rate. No "Vapor Binding".